

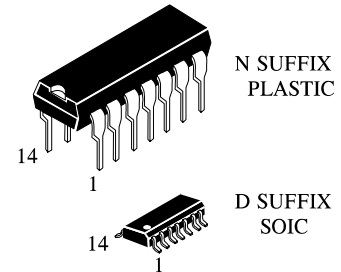
IN74LV32

Quad 2-Input OR Gate

The IN74LV32 is low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT32A.

The IN74LV32 provides the 2-input AND function.

- Optimized for Low Voltage applications: 1.2 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7\text{ V}$ and $V_{CC} = 3.6\text{ V}$
- Low Input Current

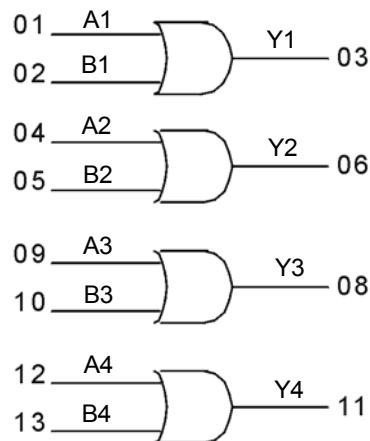


ORDERING INFORMATION

IN74LV32N Plastic
IN74LV32D SOIC

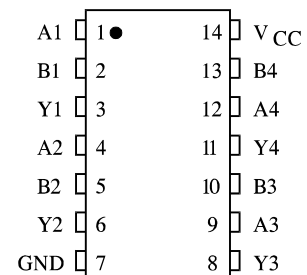
$T_A = -40^\circ \div 125^\circ\text{ C}$ for all packages

LOGIC DIAGRAM



PIN 14 = V_{CC}
PIN 7 = GND

PIN ASSIGNMENT



FUNCTION TABLE

Input		Output
A	B	$Y = A*B$
L	L	L
L	H	H
H	L	H
H	H	H

H - high level
L - low level

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC supply voltage (Referenced to GND)	$-0.5 \div +5.0$	V
I_{IK}^{*1}	DC input diode current	± 20	mA
I_{OK}^{*2}	DC output diode current	± 50	mA
I_O^{*3}	DC output source or sink current -bus driver outputs	± 25	mA
I_{CC}	DC V_{CC} current for types with - bus driver outputs	± 50	mA
I_{GND}	DC GND current for types with - bus driver outputs	± 50	mA
P_D	Power dissipation per package, plastic DIP+ SOIC package+	750 500	mW
T_{stg}	Storage temperature	$-65 \div +150$	°C
T_L	Lead temperature, 1.5 mm from Case for 10 seconds (Plastic DIP), 0.3 mm (SOIC Package)	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur.
Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 12 mW/°C from 70° to 125°C

SOIC Package: - 8 mW/°C from 70° to 125°C

*¹: $V_I < -0.5V$ or $V_I > V_{CC}+0.5V$

*²: $V_O < -0.5V$ or $V_O > V_{CC}+0.5V$

*³: $-0.5V < V_O < V_{CC}+0.5V$

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	1.2	3.6	V
V_{IN}, V_{OUT}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V_{CC}	V
T_A	Operating Temperature, All Package Types	-40	+125	°C
t_r, t_f	Input Rise and Fall Time			
	$V_{CC}=1.2V$	0	1000	ns
	$V_{CC}=2.0V$	0	700	
	$V_{CC}=3.0V$	0	500	
	$V_{CC}=3.6V$	0	400	

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V _{CC} , V	Guaranteed Limit						Unit	
				25°C		-40°C ÷ 85°C		-40°C ÷ 125°C			
				min	max	min	max	min	max		
V _{IH}	High-Level Input Voltage		1.2	0.9	-	0.9	-	0.9	-	V	
			2.0	1.4	-	1.4	-	1.4	-		
			3.0	2.1	-	2.1	-	2.1	-		
			3.6	2.5	-	2.5	-	2.5	-		
V _{IL}	Low -Level Input Voltage		1.2	-	0.3	-	0.3	-	0.3	V	
			2.0	-	0.6	-	0.6	-	0.6		
			3.0	-	0.9	-	0.9	-	0.9		
			3.6	-	1.1	-	1.1	-	1.1		
V _{OH}	High-Level Output Voltage	V _I = V _{IL} or V _{IH} I _O = -50 µA	1.2	1.1	-	1.0	-	1.0	-	V	
			2.0	1.92	-	1.9	-	1.9	-		
			3.0	2.92	-	2.9	-	2.9	-		
			3.6	3.52	-	3.5	-	3.5	-		
			V _I = V _{IL} or V _{IH} I _O = -6.0 mA	3.0	2.48	-	2.34	-	2.20	-	V
V _{OL}	Low-Level Output Voltage	V _I = V _{IL} or V _{IH} I _O = 50 µA	1.2	-	0.09	-	0.1	-	0.1	V	
			2.0	-	0.09	-	0.1	-	0.1		
			3.0	-	0.09	-	0.1	-	0.1		
			3.6	-	0.09	-	0.1	-	0.1		
			V _I = V _{IL} or V _{IH} I _O = 6.0 mA	3.0	-	0.33	-	0.4	-	0.5	V
I _{IL}	Low-Level Input Leakage Current	V _I = 0 V	3.6	-	-0.1	-	-1.0	-	-1.0	µA	
I _{IH}	High-Level Input Leakage Current	V _I = V _{CC}	3.6	-	0.1	-	1.0	-	1.0	µA	
I _{CC}	Quiescent Supply Current (per Package)	V _I = 0 B or V _{CC} I _O = 0 µA	3.6	-	2.0	-	20	-	40	µA	

AC ELECTRICAL CHARACTERISTICS ($C_L=50$ pF, $t_{LH} = t_{HL} = 6.0$ ns, $V_{IL} = 0V$, $V_{IH}=V_{CC}$, $R_L=1k\Omega$)

Symbol	Parameter	V _{CC} V	Guaranteed Limit						Unit
			25°C		-40°C ÷ 85°C		-40°C ÷ 125°C		
			min	max	min	max	min	max	
t _{THL} , (t _{TLH})	Output Transition Time, Any Output (Figure 1)	1.2	-	60	-	75	-	90	ns
		2.0	-	16	-	20	-	24	
		*	-	10	-	13	-	15	
t _{PHL} , (t _{PLH})	Propagation Delay, Input A to Output Y (Figure 1)	1.2	-	125	-	360	-	360	
		2.0	-	20	-	25	-	30	
		*	-	12	-	15	-	18	
C _I	Input Capacitance	3.0	-	7.0	-	-	-	-	pF

C _{PD}	Power Dissipation Capacitance (Per Gate)	T _A =25°C, V _I =0V÷V _{CC}	pF
		44	

* - $V_{CC} = (3.3 \pm 0.3)$ V

$P_D = C_{PD} V_{CC}^2 f_i + \sum (C_L V_{CC}^2 f_o)$, f_i -input frequency, f_o - output frequency (MHz)

$\sum (C_L V_{CC}^2 f_o)$ – sum of the outputs

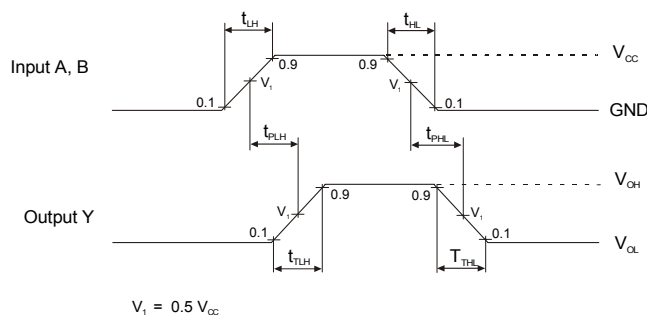


Figure 1. Switching Waveforms

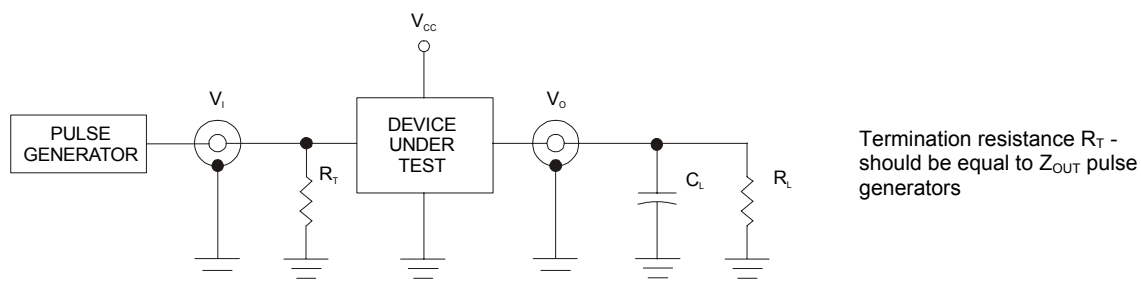
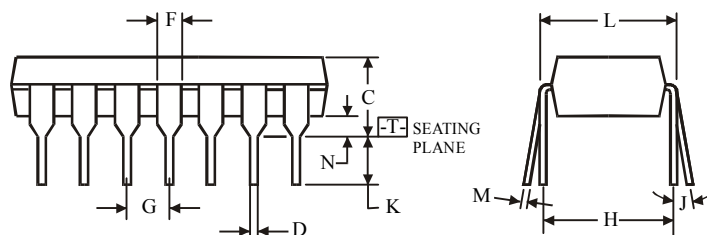
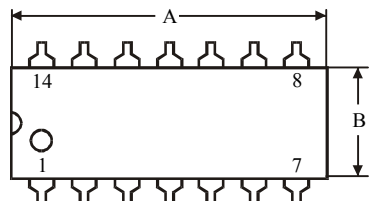
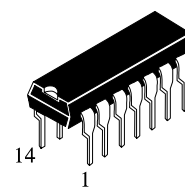


Figure 2. Test Circuit

N SUFFIX PLASTIC DIP (MS - 001AA)



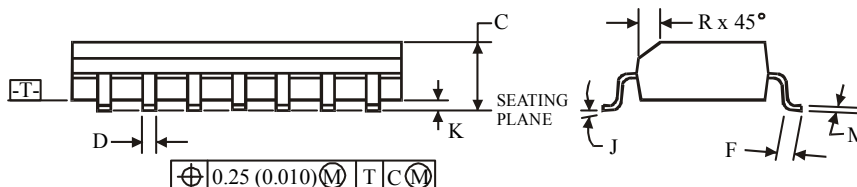
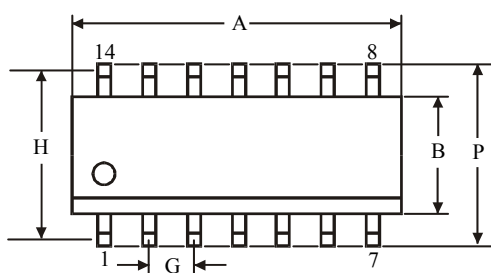
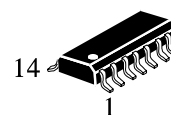
$\oplus 0.25 (0.010) \text{ (M) T}$

NOTES:

- Dimensions "A", "B" do not include mold flash or protrusions.
Maximum mold flash or protrusions 0.25 mm (0.010) per side.

	Dimension, mm	
Symbol	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

D SUFFIX SOIC (MS - 012AB)



$\oplus 0.25 (0.010) \text{ (M) T C (M)}$

NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side
for A; for B - 0.25 mm (0.010) per side.

	Dimension, mm	
Symbol	MIN	MAX
A	8.55	8.75
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	5.27	
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5